High—speed switching diode

Applications

High speed switching

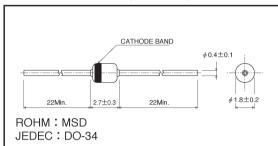
Features

- 1) Glass sealed envelope. (MSD)
- 2) High reliability.
- 3) High speed. (typical recovery time = 1.5ns)

Construction

Silicon epitaxial planar

External dimensions (Units: mm)



Cathode band colors

Туре	Color
1SS133	Yellow

● Absolute maximum ratings (Ta = 25°C)

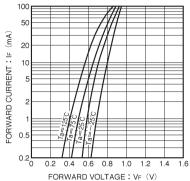
Parameter	Symbol	Limits	Unit	Parameter	Symbol	Limits	Unit
Peak reverse voltage	V _{RM}	90	V	Surge current (1s)	Isurge	600	mA
DC reverse voltage	VR	80	V	Power dissipation	Р	300	mW
Peak forward current	Іғм	400	mA	Junction temperature	Tj	175	°C
Mean rectifying current	lo	130	mA	Storage temperature	Tstg	-65~+175	°C

• Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	_	0.92	1.2	V	I _F =100mA
Reverse current	IR	_	0.020	0.5	μΑ	V _R =80V
Capacitance between terminals	Ст	_	1.55	2	pF	V _R =0.5V, f=1MHz
Reverse recovery time	trr	_	1.5	4	ns	V _R =6V, I _F =10mA, R _L =50Ω

Diodes 1SS133

●Electrical characteristic curves (Ta = 25°C unless specified otherwise)



O.2 0.4 0.6 0.8 1.0 1.2 1.4 1
FORWARD VOLTAGE: VF (V)
Fig. 1 Forward characteristics

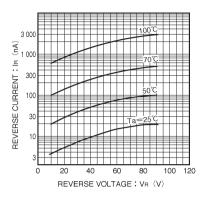


Fig. 2 Reverse characteristics

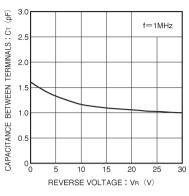


Fig. 3 Capacitance between terminals characteristics

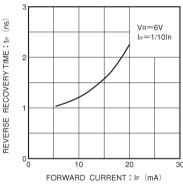


Fig. 4 Reverse recovery time characteristics

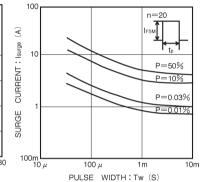


Fig. 5 Surge current characteristics

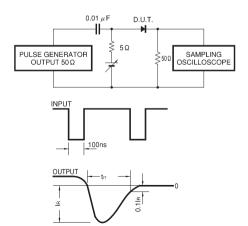


Fig. 6 Reverse recovery time (trr) measurement circuit

2